



GBJ50005 thru GBJ5010

50.0 A Single-Phase Silicon Bridge Rectifier Rectifier Reverse Voltage 50 to 1000V

GBJ

Features

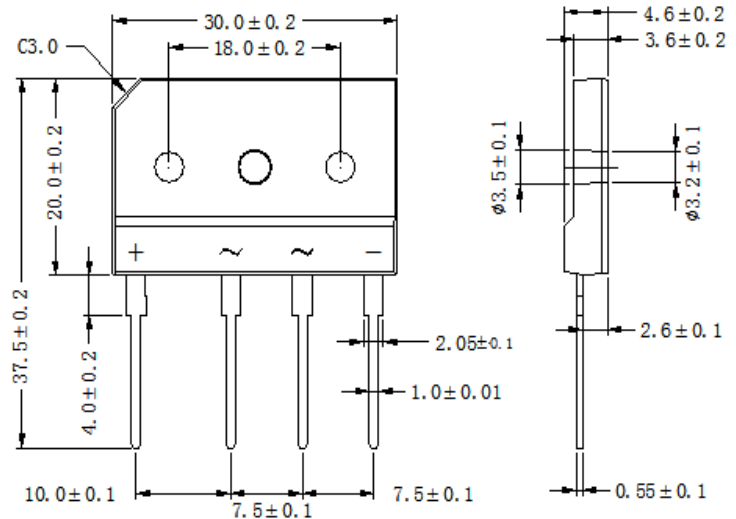
- Ideal for printed circuit board mounting
- This series is UL listed under the Recognized Component Index, file number E484648
- The plastic material used carries Underwriters Laboratory flammability recognition 94V-0
- Built-in printed circuit board stand-offs
- High case dielectric strength
- High temperature soldering guaranteed 260°C/10 seconds at 5 lbs (2.3kg) tension

Mechanical Data

Case: Reliable low cost construction utilizing molded plastic technique

Terminals: Plated leads solderable per MIL-STD-202, Method 208

Mounting Position: Any



Dimensions in inches and (millimeters)

Maximum Ratings & Thermal Characteristics

Rating at 25°C ambient temperature unless otherwise specified, Resistive or Inductive load, 60 Hz.
For Capacitive load derate current by 20%.

Parameter	Symbol	GBJ 50005	GBJ 5001	GBJ 5002	GBJ 5004	GBJ 5006	GBJ 5008	GBJ 5010	unit
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS bridge input voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward (with heatsink Note2) Rectified Current @ $T_C=100^\circ\text{C}$	$I_{F(AV)}$	50.0							A
Peak forward surge current single sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	500							A
Rating for fusing ($t < 8.3\text{ms}$)	$I^2 t$	1037							A ² sec
Operating junction and storage temperature range	T_J , T_{STG}	-55 to + 150							°C

Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified. Resistive or Inductive load, 60Hz.
For Capacitive load derate by 20 %.

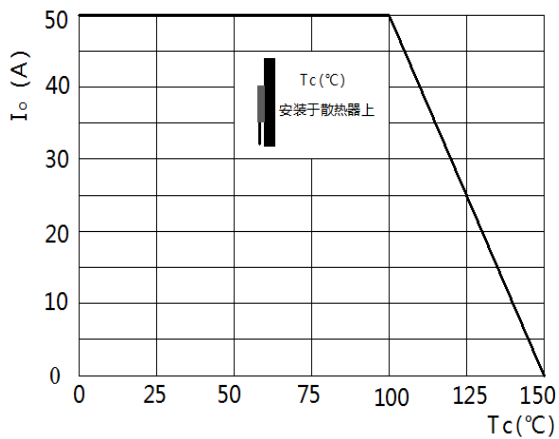
Parameter	Symbol	GBJ 50005	GBJ 5001	GBJ 5002	GBJ 5004	GBJ 5006	GBJ 5008	GBJ 5010	Unit
Maximum instantaneous forward voltage drop per leg at 25.0A	V_F	1.1							V
Maximum DC reverse current at rated $T_A=25^\circ\text{C}$ DC blocking voltage per element $T_A=125^\circ\text{C}$	I_R	10 500							μA

Notes: (1) Thermal resistance from Junction to Ambient on P.C. board mounting.

(2) Device mounted on 300mm*300mm*1.6mm cu plate heatsink.

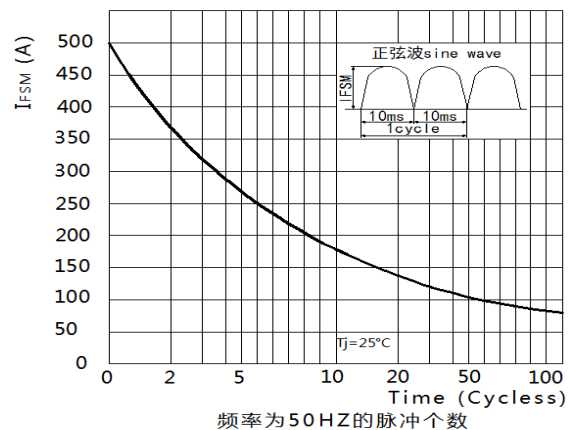
Rating and Characteristic Curves ($T_A=25^{\circ}\text{C}$ Unless otherwise noted) GBJ50005 thru GBJ5010

FIG.1-FORWARD CURRENT DERATING CURVE



CASE TEMPERATURE, °C

FIG.2-MAXMUN NON-REPETITIVE SURGE CURRENT



频率为 50 HZ 的脉冲个数

FIG.3-TYPICAL REVERSE

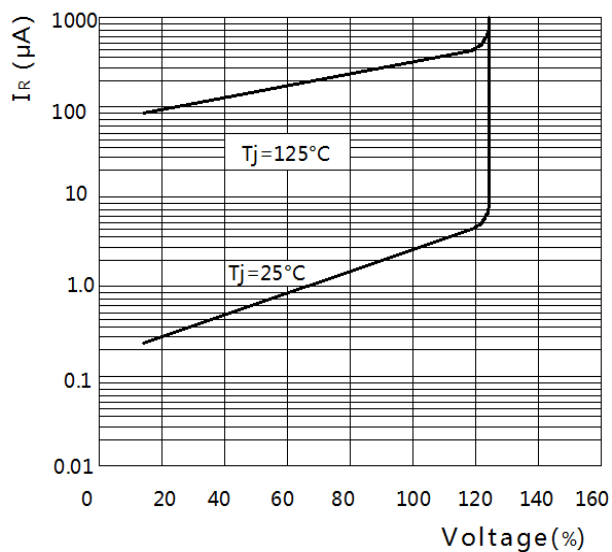


FIG.4-TYPICAL FORWARD CHARACTERISTICS

